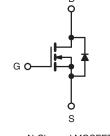
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	700)
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.145
Q _g max. (nC)	122	2
Q _{gs} (nC)	21	
Q _{gd} (nC)	37	
Configuration	Sing	le





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP24N65E-E3
Lead (Pb)-free and Halogen-free	SiHP24N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C =	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	650	v
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T _{.1} = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		24	
Continuous Drain Current $(1_j = 150 \text{ C})$	V _{GS} at 10 V	T _C = 100 °C	ID	16	А
Pulsed Drain Current ^a			I _{DM}	70	
Linear Derating Factor				2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	508	mJ
Maximum Power Dissipation			P _D	250	W
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$T_{\rm J} = 1$	125 °C	-1) / / -1+	37	
Reverse Diode dV/dt ^d			dV/dt	11	V/ns
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 6$ A.

c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/µs, starting $T_J = 25$ °C.

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		62 0.5				
Maximum Junction-to-Case (Drain)	R _{thJC}	-				°C/W		
			I					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C_{,1}$	inless otherw	ise noted)						
PARAMETER	SYMBOL	1	CONDITIONS		MIN.	TYP.	MAX.	UNI
Static	0111202						10000	
Drain-Source Breakdown Voltage	V _{DS}	Vee	= 0 V, I _D = 250 μA		650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		$\frac{1}{10} = \frac{1}{10} $	μA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	V_{GS} , $I_D = 250 \ \mu A$	P., (2	-	4	V
	• GS(III)		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	-	± 1	μA
			$= 650 \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}$		-	-	1	μ. ι
Zero Gate Voltage Drain Current	I _{DSS}	-	$V_{\rm r}, V_{\rm GS} = 0 \text{ V}, \text{ T}_{\rm J} = 1$	25 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_{\rm D} = 12 \rm{A}$		-	0.120	0.145	Ω
Forward Transconductance	9fs		$_{3} = 8 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		-	7.1	-	S
Dynamic	013			Į		Ļ		
Input Capacitance	C _{iss}	<u> </u>		-	2740	-		
Output Capacitance	C _{oss}	-	V _{GS} = 0 V, V _{DS} = 100 V,		-	122	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-	pF	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	93	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	- V _{DS} = 0 V	′ to 520 V, V _{GS} = 0	V	-	352	-	
Total Gate Charge	Qg				-	81	122	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 12 A, V _{DS} =	= 520 V	-	21	-	nC
Gate-Drain Charge	Q _{qd}			-	-	37	-	
Turn-On Delay Time	t _{d(on)}				-	24	48	
Rise Time	t _r		520 \/ I= - 12 A	ľ	-	84	126	1
Turn-Off Delay Time	t _{d(off)}	VDD - V _{GS} -	V_{DD} = 520 V, I _D = 12 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	70	105	ns
Fall Time	t _f				-	69	104	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.68	-	Ω	
Drain-Source Body Diode Characterist	cs	•				•		•
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	-	24	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	70	A
Diode Forward Voltage	V _{SD}	T _{.J} = 25 °C	C, I _S = 12 A, V _{GS} =	0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}				-	433	-	ns
Reverse Recovery Charge	Q _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 12 \text{ A},$, I	-	7.3	-	μC
Reverse Recovery Current	I _{RRM}	dl/dt =	100 A/µs, V _R = 25	v	_	28		A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

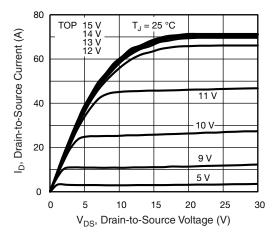


Fig. 1 - Typical Output Characteristics

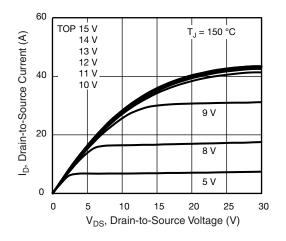


Fig. 2 - Typical Output Characteristics

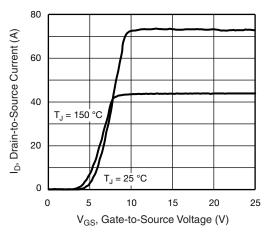


Fig. 3 - Typical Transfer Characteristics

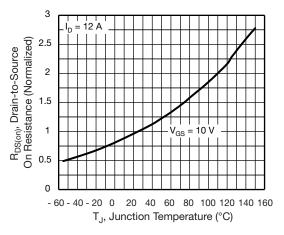


Fig. 4 - Normalized On-Resistance vs. Temperature

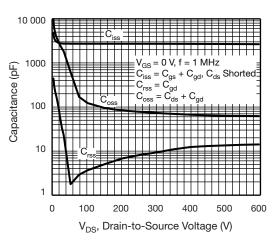
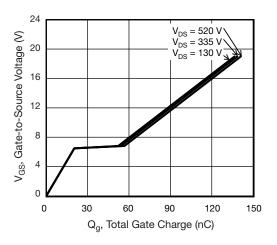


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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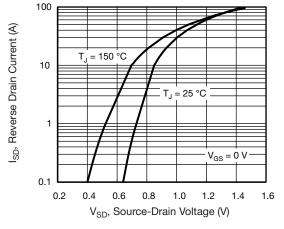


Fig. 7 - Typical Source-Drain Diode Forward Voltage

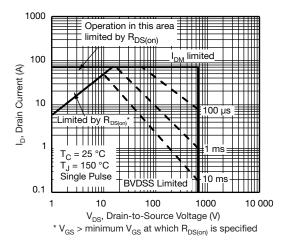


Fig. 8 - Maximum Safe Operating Area

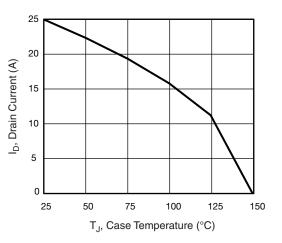


Fig. 9 - Maximum Drain Current vs. Case Temperature

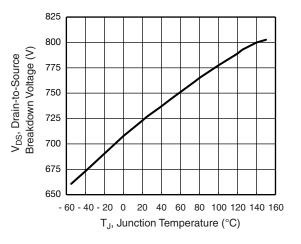
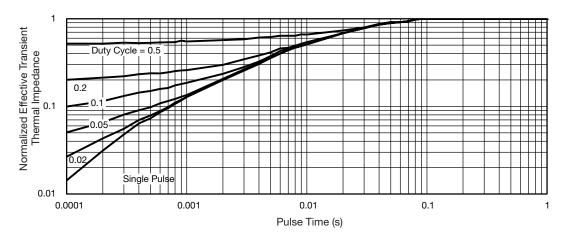
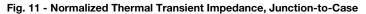


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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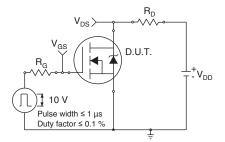


Fig. 12 - Switching Time Test Circuit

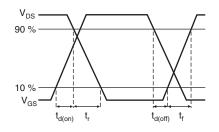


Fig. 13 - Switching Time Waveforms

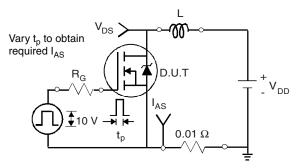


Fig. 14 - Unclamped Inductive Test Circuit

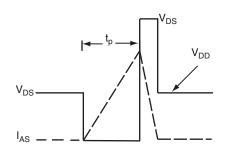
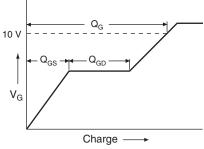


Fig. 15 - Unclamped Inductive Waveforms



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Fig. 16 - Basic Gate Charge Waveform

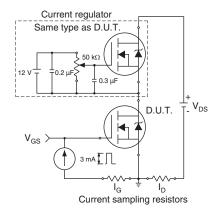


Fig. 17 - Gate Charge Test Circuit

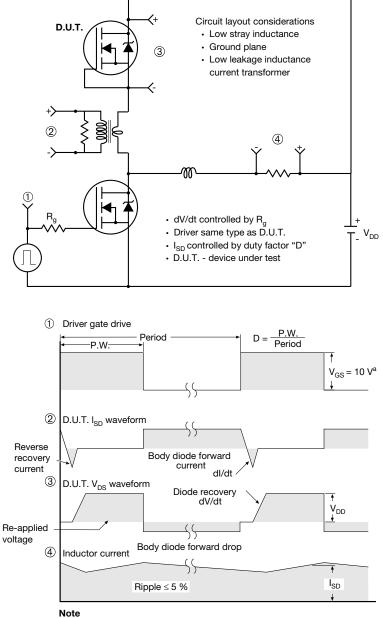
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Revison: 04-Nov-2021



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